Transient Voltage Suppression Diodes

Surface Mount - 4000W > 4.0SMDJ24A

4.0SMDJ24A











Agency Approvals

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AGENCY FILE NUMBER

E230531

Maximum Ratings and Thermal Characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T_A =25°C by 10/1000 μ s Waveform (Fig.2)(Note 1), (Note 2)	P _{PPM}	4000	W
Power Dissipation on Infinite Heat Sink at T_L =50°C	P _D	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I _{FSM}	300	А
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	V _F	3.5	V
Operating Temperature Range	T _J	-65 to 150	°C
Storage Temperature Range	T _{stg}	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	R _{eJL}	15	°C/W
Typical Thermal Resistance Junction to Ambient	R _{eJA}	75	°C/W

Notes:

- 1. Non-repetitive current pulse , per Fig. 4 and derated above T, (initial) =25°C per Fig. 3.
- 2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal
- 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum

Description

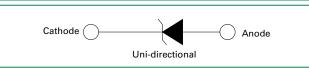
The 4.0SMDJ24A is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- 4000W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- For surface mounted applications in order to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- V_{BR} @ T_J= V_{BR}@25°C $\times (1 + \alpha T \times (T_1 - 25))$ (a T:Temperature Coefficient, typical value is 0.1%)

- Glass passivated chip junction
- Fast response time: typically less than 1.0ps from 0V to BV min
- Excellent clamping capability
- · Low incremental surge resistance
- High temperature to reflow soldering quaranteed: 260°C/40sec at terminals
- Meet MSL level1, per J-STD-020, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Functional Diagram



Applications

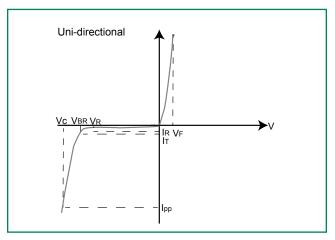
TVS devices are ideal for the protection of I/O Interfaces. V_{cc} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

Electrical Characteristics (T_a=25°C unless otherwise noted)

Part Number Marking	Marking	Reverse Stand off Voltage V _R (Volts)	Breakdown Voltage V _{BR} (Volts) @ I _T		Test Current	Maximum Clamping Voltage V _c @ I	Maximum Clamping Voltage V _c @	Maximum Peak Pulse Currentl _{op}	Maximum Peak Pulse Current I _{pp}	Maximum Reverse Leakage I _R
			MIN	MAX	'⊤ (mA)	(10/1000µS) (V)	(8/20µS) (V)	(10/1000µS) (A)	(8/20µS) ^r (A)	@ V _R (μΑ)
4.0SMDJ24A	4PEZ	24.0	26.70	29.50	1	38.9	51.0	103.0	650.0	2



I-V Curve Characteristics



- P_{PPM} Peak Pulse Power Dissipation Max power dissipation
- $V_{\scriptscriptstyle B}$ Stand-off Voltage Maximum voltage that can be applied to the TVS without operation
- V_{BR} Breakdown Voltage -- Maximum voltage that flows though the TVS at a specified test current (I₇)
- V_c Clamping Voltage Peak voltage measured across the TVS at a specified Ippm (peak impulse current)
- I_R Reverse Leakage Current -- Current measured at V_R
- V_F Forward Voltage Drop for Uni-directional

Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

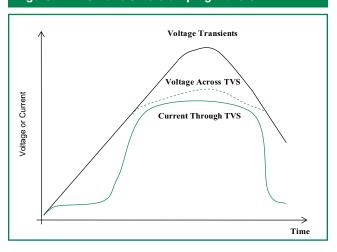
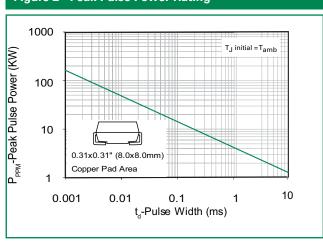


Figure 2 - Peak Pulse Power Rating



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Additional Infomation







Ratings and Characteristic Curves (T_a=25°C unless otherwise noted) (Continued)

Figure 3 - Peak Pulse Power Derating Curve

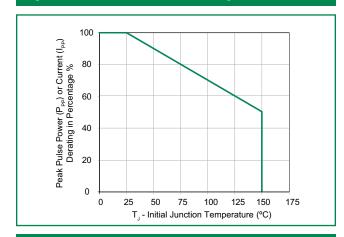


Figure 5 - Typical Transient Thermal Impedance

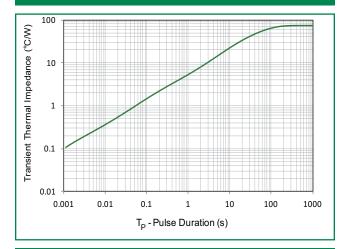


Figure 7 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)

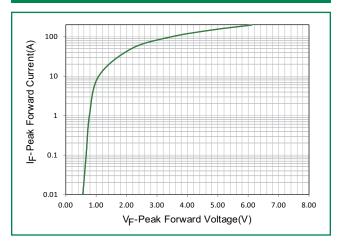


Figure 4 - Pulse Waveform

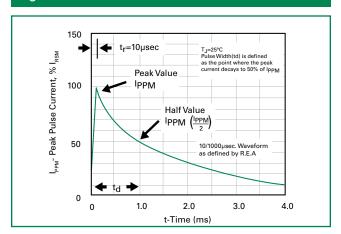
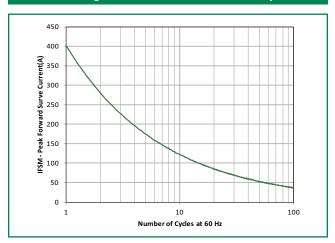


Figure 6 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional Only



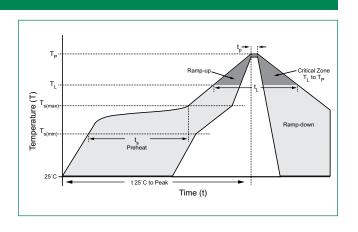
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Soldering Parameters

Reflow Cor	ndition	Lead-free assembly	
Pre Heat	-Temperature Min (T _{s(min)})	150°C	
	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average rai	mp up rate (Liquidus Temp (T _A)	3°C/second max	
$T_{S(max)}$ to T_A	- Ramp-up Rate	3°C/second max	
Reflow	-Temperature (T _A) (Liquidus)	217°C	
nellow	-Time (min to max) (t _s)	60 – 150 seconds	
Peak Temp	erature (T _P)	260 ^{+0/-5} °C	
Time within	n 5°C of actual peak re (t _p)	20 – 40 seconds	
Ramp-dow	n Rate	6°C/second max	
Time 25°C	to peak Temperature (T _P)	8 minutes Max.	
Do not exc	eed	260°C	



Physical Specifications

Weight	0.007 ounce, 0.21 grams			
Case	JEDEC DO214AB. Molded plastic body over glass passivated junction			
Polarity	Color band denotes positive end (cathode) except Bidirectional.			
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102			

High Temp. Storage High Temp. Storage JESD22-A103 HTRB JESD22-A108 Temperature Cycling JESD22-A104 MSL JEDEC-J-STD-020, Level 1 H3TRB JESD22-A101

JESD22-A111

Dimensions

DO-214AB (SMC J-Bend)

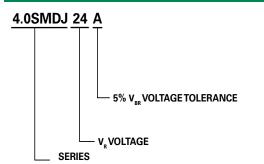
Dimensions	Incl	hes	Millimeters		
Dimensions	Min	Max	Min	Max	
А	0.114	0.126	2.900	3.200	
В	0.260	0.280	6.600	7.110	
С	0.220	0.245	5.590	6.220	
D	0.079	0.103	2.060	2.620	
E	0.030	0.060	0.760	1.520	
F	-	0.008	-	0.203	
G	0.305	0.320	7.750	8.130	
Н	0.006	0.012	0.152	0.305	
1	0.129	-	3.300	-	
J	0.094	-	2.400	-	
K	-	0.165		4.200	
L	0.094	-	2.400	-	

RSH

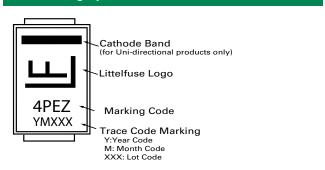
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Part Numbering System



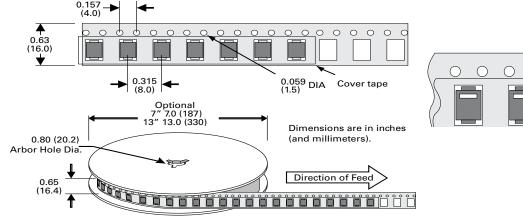
Part Marking System



Packaging Options

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
4.0SMDJ24A	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481

Tape and Reel Specification





单击下面可查看定价,库存,交付和生命周期等信息

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